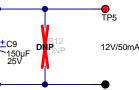
	1	2	3	4	5	6
A			L1 330µH		• • • • • • • • • • • • • • • • • • •	
	85V	AC-265VAC				_
в		LINE O_{TP1} O443003.DR $C4$ $O.22\mu F$ SGNC NTRL O_{TP2} Aux $R2$ $O_{MMSD4148T10}$		D2 MURS360T3G	+C2 47μF C3 1μF DP TP4 GND 1213	
			SGND R7			
			SGND R7 7.68k DR5NP UCC28730DR S SGND SGND	1.15k R9 R10 0.56 0.56 SGND		
с			80V T	U2 HVIN DRAIN 4 VDD FB 0.022µF 6 NC GND_IC UCC28880D D5 MURA11	D4 MMDL914-TP 77 .1µF L2 680µH 744732681 +C9 150µF DBB12 12V/50mA	
					TP6 GND	
D						1
					Orderable: ChangeMe! Designed for: Public Release TID #: N/A Project Title: 80V/50W Upside Downside	Mod. Date: 3/27/2017
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	1	licensors do not warrant that the desi 2	n is production worthy. You should completely validate and tes 3	t your design implementation to confirm the system functionality for your application. 4	Engineer: C Sarli Contact: http://www.ti.com/suppor 5	© Texas Instruments 2016 6

● _{₽3} 80V@0.625	A
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